



Applicant Guide to HIRP 2019

Huawei Innovation Research Program (HIRP) provides funding opportunities to leading universities and research institutes conducting innovative research in communication technology, computer science, engineering, and related fields. HIRP seeks to identify and support world-class, full-time faculty members, sets up win-win collaboration and pursues technology innovation of mutual interest.

As a part of HIRP, HIRP OPEN is a 1-1.5 year award that supports contract-based innovation research with the amount up to USD 70,000.

HIRP 2019 Round 1 is coming now, and relevant subjects are published on May 10th, 2019. Proposals for other innovative subjects about listed specific technical areas are also welcome.

JOIN US TO SHAPE THE INNOVATION

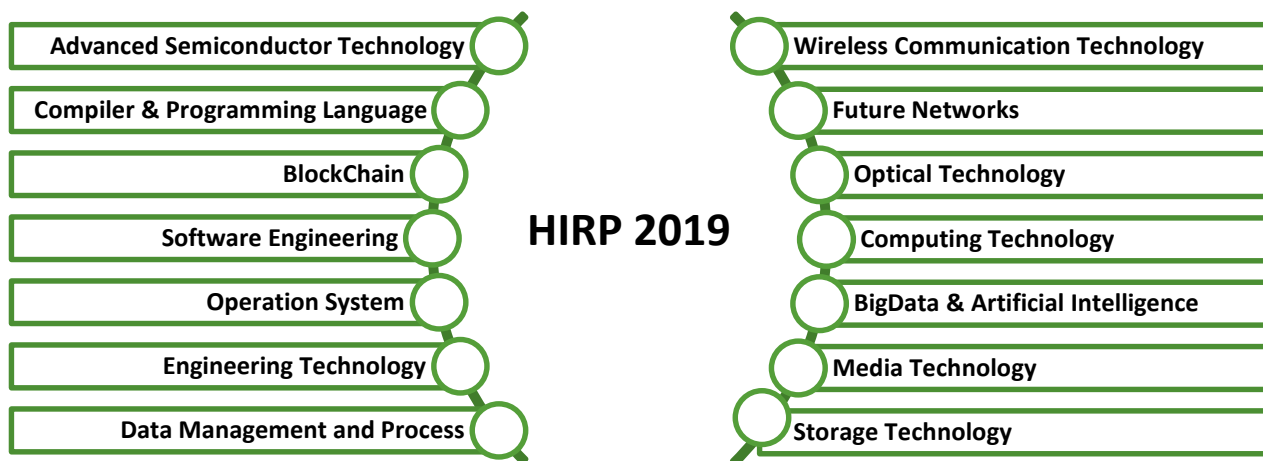
Each applicant must be a full-time faculty members, research staffs, and post-docs at a non-profit academic, university or research institution around the world. We do not accept applications from professors on behalf of students, post-docs, or others not eligible to apply.

HIRP 2019 Round 1 Timeline



Please refer to the website specification for the submission deadline of each subject.

HIRP 2019 Round 1 will include about 120 research subjects involving 18 technical fields. The main fields are as follows:



For further inquiry and any comments, please visit <http://innovationresearch.huawei.com> for more information.

*Notes: Please use IE or Chrome and set security level to MEDIUM.
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